

Multilayer Ceramic Capacitors

TDK expands inline structure and low-resistance type MEGACAP MLCCs with metal frames for automotive

- The automotive-grade inline structure MEGACAP MLCCs are qualified based on the automotive standard AEC-Q200
- · Low resistance achieved by optimizing metal frame materials
- Lineup includes 99 nF/1000 V with Class 1 and 47 $\mu\text{F}/100$ V with Class 2 dielectric

September 10, 2024

TDK Corporation (TSE:6762) has extended the automotive-grade CA series of its MEGACAP MLCCs with a metal frame. Mass production of the product series began in September 2024.

In recent years, the development of automobiles with electric powertrains, such as hybrid- (HEVs) and batteryelectric vehicles (BEVs), and highly efficient charging technologies, has significantly progressed. Both help to reduce greenhouse gas emissions. In these applications, the power consumption of various subsystems including inverters, onboard chargers (OBCs), and wireless power transfer (WPT) systems is increasing, and MLCCs must handle high currents and have large capacitance.

To meet these needs, TDK developed the CA series, the largest MLCCs in the industry^{*} (6.00 x 5.60 x 6.40 mm) with a metal frame and 3-line type structure. TDK now provides an extensive lineup including 99 nF/1000 V with a Class 1 dielectric and 47 μ F/100 V with a Class 2 dielectric.

To handle high currents, TDK has reduced the equivalent series resistance (ESR) compared to the previous products by optimizing the materials of the metal frame. This helps reduce the number of components and miniaturizes devices. TDK will further expand its lineup to meet the needs of customers.

* As of September 2024, according to TDK

Main applications

- · Smoothing and decoupling of the power lines
- Resonant circuits in subsystems such as OBCs and WPTs
- Snubber circuits in inverters

Main features and benefits

- · Low resistance achieved by optimizing metal frame materials
- High capacitance achieved using multiple MLCCs to help reduce the number of components and miniaturizing devices
- High reliability qualified based on AEC-Q200



Туре	Outer dimensions [mm] (L x W x H)	Туре	Temperature characteristics	Rated voltage [V]	Capacitance [F]
CAA572C0G3A203J640LJ	6.00 x 5.60 x 6.40	2 - line	C0G	1000	20 n
CAA572C0G3A303J640LJ	6.00 x 5.60 x 6.40	2 - line	C0G	1000	30 n
CAA572C0G3A443J640LJ	6.00 x 5.60 x 6.40	2 - line	C0G	1000	44 n
CAA572C0G3A663J640LJ	6.00 x 5.60 x 6.40	2 - line	C0G	1000	66 n
CAA573C0G3A993J640LJ	6.00 x 8.40 x 6.40	3 - line	C0G	1000	99 n
CAA572C0G2J204J640LJ	6.00 x 5.60 x 6.40	2 - line	C0G	630	200 n
CAA573C0G2J304J640LJ	6.00 x 8.40 x 6.40	3 - line	C0G	630	300 n
CAA572X7T2J105M640LJ	6.00 x 5.00 x 6.40	2 - line	Х7Т	630	1μ
CAA573X7T2J155M640LJ	6.00 x 7.50 x 6.40	3 - line	Х7Т	630	1.5 µ
CAA572X6T2W225M640LJ	6.00 x 5.00 x 6.40	2 - line	Х6Т	450	2.2 µ
CAA573X6T2W335M640LJ	6.00 x 7.50 x 6.40	3 - line	Х6Т	450	3.3 µ
CAA572X7T2V225M640LJ	6.00 x 5.00 x 6.40	2 - line	Х7Т	350	2.2 µ
CAA573X7T2V335M640LJ	6.00 x 7.50 x 6.40	3 - line	Х7Т	350	3.3 µ
CAA572X7S2A336M640LJ	6.00 x 5.00 x 6.40	2 - line	X7S	100	33 µ
CAA573X7S2A476M640LJ	6.00 x 7.50 x 6.40	3 - line	X7S	100	47 μ
CAA572X7R1V107M670LJ	6.25 x 5.00 x 6.70	2 - line	X7R	35	100 µ
CAA573X7R1V157M670LJ	6.25 x 7.50 x 6.70	3 - line	X7R	35	150 µ
CAA572X7R1E107M670LJ	6.25 x 5.00 x 6.70	2 - line	X7R	25	100 µ
CAA573X7R1E157M670LJ	6.25 x 7.50 x 6.70	3 - line	X7R	25	150 µ

Samples may be purchased from the product page that is displayed after clicking Type.



About TDK Corporation

TDK Corporation is a world leader in electronic solutions for the smart society based in Tokyo, Japan. Built on a foundation of material sciences mastery, TDK welcomes societal transformation by resolutely remaining at the forefront of technological evolution and deliberately "Attracting Tomorrow." It was established in 1935 to commercialize ferrite, a key material in electronic and magnetic products. TDK's comprehensive, innovation-driven portfolio features passive components such as ceramic, aluminum electrolytic and film capacitors, as well as magnetics, high-frequency, and piezo and protection devices. The product spectrum also includes sensors and sensor systems such as temperature and pressure, magnetic, and MEMS sensors. In addition, TDK provides power supplies and energy devices, magnetic heads and more. These products are marketed under the product brands TDK, EPCOS, InvenSense, Micronas, Tronics and TDK-Lambda. TDK focuses on demanding markets in automotive, industrial and consumer electronics, and information and communication technology. The company has a network of design and manufacturing locations and sales offices in Asia, Europe, and in North and South America. In fiscal 2024, TDK posted total sales of USD 14.6 billion and employed about 101,000 people worldwide.

You can download this text and associated images from https://www.tdk.com/en/news_center/press/20240910_01.html Further information on the products can be found under https://product.tdk.com/en/news_center/press/20240910_01.html Further information on the products can be found under https://product.tdk.com/system/files/dam/doc/product/capacitor/ceramic/mlcc/catalog/mlcc_automotive_megacap_ca_en.pdf

Contacts for regional media

Region	Contact		Phone	Mail
Japan	Mr. Daiki ITO	TDK Corporation Tokyo, Japan	+813 6778-1055	TDK.PR@tdk.com
ASEAN	Ms. Jiang MAN Ms. Pei Lu LEE	TDK Singapore (Pte) Ltd. Singapore	+65 6273 5022	tdk.asean-inquiry@tdk.com
Greater China	Ms. Clover XU	TDK China Co., Ltd. Shanghai, China	+86 21 61962307	TDK.PR-CN@tdk.com
Europe	Mr. Frank TRAMPNAU	TDK Management Services GmbH Duesseldorf, Germany	+49 211 9077 127	frank.trampnau@tdk.com
America	Ms. Sara M. LAMBETH	TDK Corporation of America Plano, TX, USA	+1 972-409-4519	sara.lambeth@tdk.com